

Team Meeting- 09/25/14 [Instructor, and Mentor will be present]

Agenda 4:

Specifications (Pankaj Dhyani)

- Marketing Specifications
- Engineering Specifications
- Design Specifications

PCB (Pankaj Dhyani)

- Footprints
- Design for one IC to test on breadboard
- Prototype design after testing

Switch Interface (Abraham Martinez)

- TLP3100 6-SOP Function
- The 6-SOP Photocoupler Photorelay on DIP
- Testing

Modularity (Ryler Adams)

- 3D visual sketches
- Graphic visual in explanation
- Final product possibility